

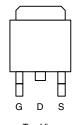
Vishay Siliconix

COMPLIANT

N-Channel 150 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)		
150	0.073 at V _{GS} = 10 V	23		
150	0.077 at V _{GS} = 6 V	22.5		

TO-263



Top View

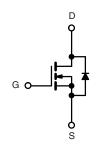
Ordering Information: SUM23N15-73-E3 (Lead (Pb) free)

FEATURES

- TrenchFET[®] Power MOSFETS
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- PWM Optimized
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	150	v		
Gate-Source Voltage	V _{GS}	± 20	v			
Continuous Drain Current (T ₁ = 175 °C)	T _C = 25 °C	L	23			
	T _C = 125 °C	I _D	13.4	•		
Pulsed Drain Current	I _{DM}	35	- A			
Avalanche Current		I _{AR}	25			
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	31	mJ		
	T _C = 25 °C	D	100 ^b	144		
Maximum Power Dissipation ^a	T _A = 25 °C ^c		3.75	W		
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS					
Symbol	Limit	Unit			
R _{thJA}	40	°C/W			
R _{thJC}	1.5				
	R _{thJA}	R _{thJA} 40			

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

Document Number: 72143 S11-2308-Rev. B, 21-Nov-11 www.vishay.com

1

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•						
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = 250 μ A	150			v	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 120 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μΑ	
		$V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 175 ^{\circ}\text{C}$			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	35			А	
		V _{GS} = 10 V, I _D = 15 A		0.059	0.073	1	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			0.140	1	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C			0.168	Ω	
		V _{GS} = 6 V, I _D = 10 A		0.062	0.077		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 25 A	10			S	
Dynamic ^b	- I			4	،		
Input Capacitance	C _{iss}			1290		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz		160			
Reverse Transfer Capacitance	C _{rss}			70			
Total Gate Charge ^c	Qg			22	35	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 75 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 23 \text{ A}$		6			
Gate-Drain Charge ^c	Q _{gd}			7.5			
Gate Resistance	R _G			4		Ω	
Turn-On Delay Time ^c	t _{d(on)}			10	15		
Rise Time ^c	tr	V _{DD} = 75 V, R _L = 3.26 Ω		60	90	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}{\cong}23$ A, V_GEN = 10 V, R_G = 2.5 Ω		30	43		
Fall Time ^c	t _f			45	70		
Source-Drain Diode Ratings and Cha	racteristics (1	_C = 25 °C) ^b					
Continuous Current	۱ _S				35	^	
Pulsed Current	I _{SM}				23	A	
Forward Voltage ^a	V _{SD}	I _F = 23 A, V _{GS} = 0 V		1	1.5	V	
Reverse Recovery Time	t _{rr}			100	150	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = 23 A, dl/dt = 100 A/μs		5	8	А	
Reverse Recovery Charge	Q _{rr}	·		0.25	0.6	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

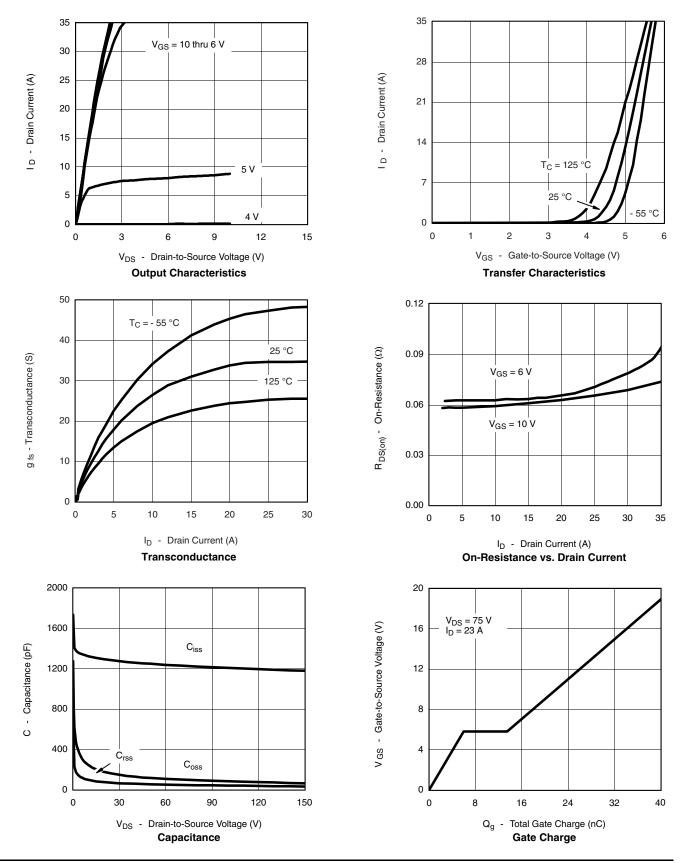
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS (25 °C unless noted)



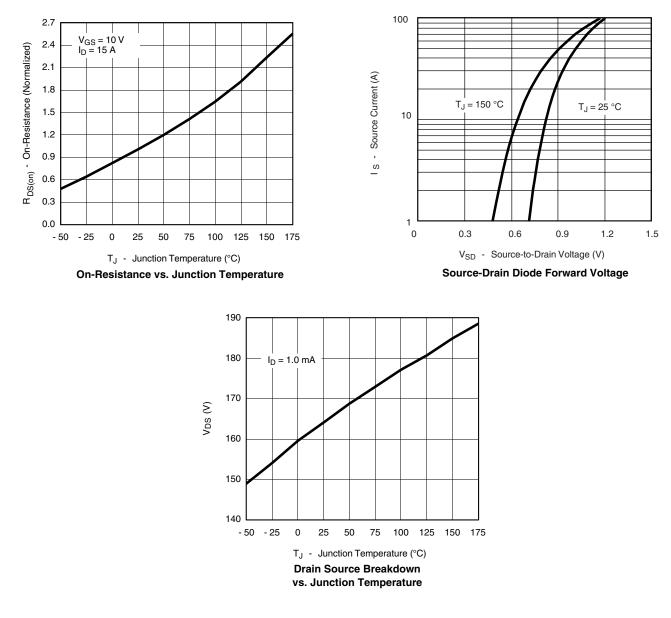
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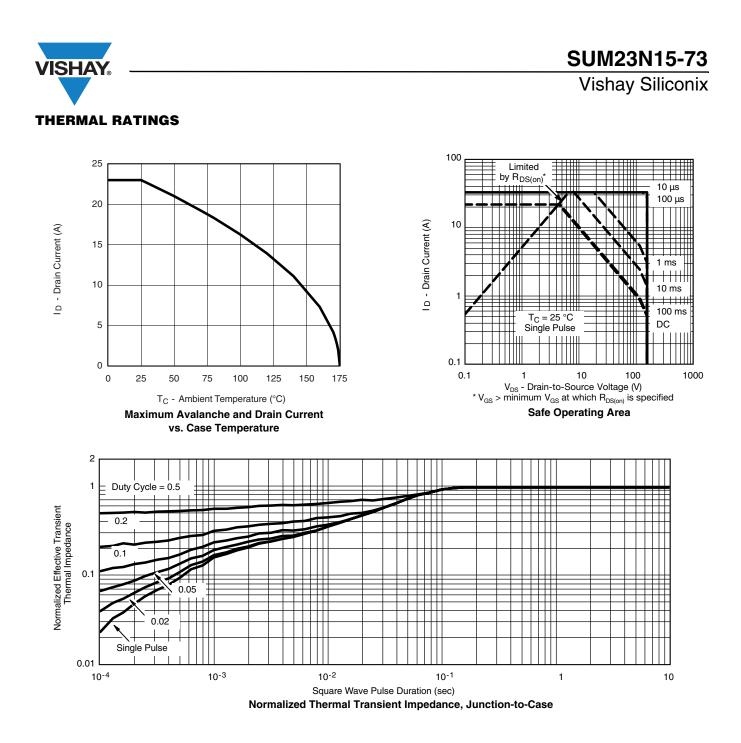
3

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TYPICAL CHARACTERISTICS (25 °C unless noted)



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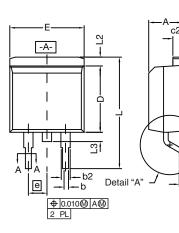
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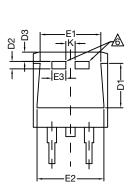


Package Information

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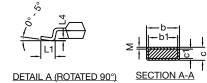
TO-263 (D²PAK): 3-LEAD





-B-

С



		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
E		0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017 9.52		
	E3	0.072	0.078	1.829 1.981		
	е	0.100 BSC		2.54 BSC		
	К	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
	L1	0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254 BSC		
M - 0.002 -		0.050				
ECN: T10-0738-Rev. J, 03-Jan-11 DWG: 5843						

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
- Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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